## **Supporting Information**

## Nanocomposites from Clay, Cellulose Nanofibrils, and Epoxy with Improved Moisture Stability for Coatings and Semistructural Applications

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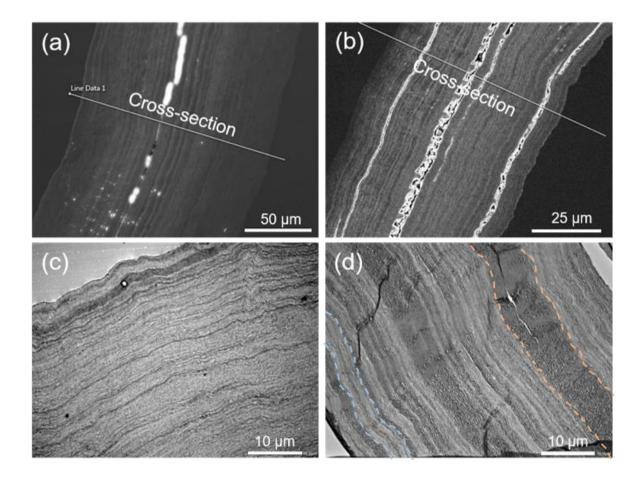
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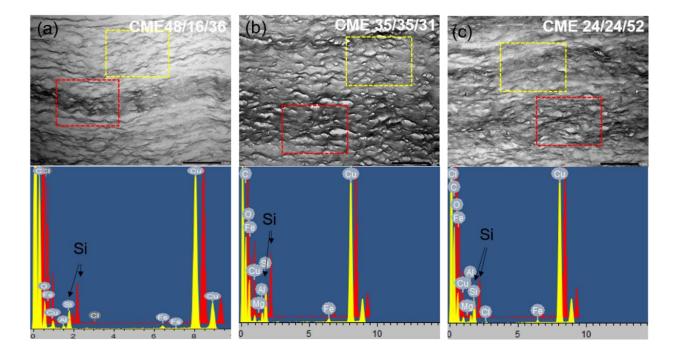
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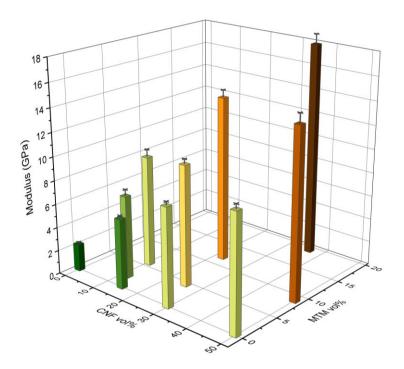
<sup>1</sup> denotes equal contribution



**Figure S1.** Low-magnification electron images of flat cross-sections. SEM images of (a) CME 30/10/60 (b) CME 35/35/31 composite (5 kV voltage). TEM images of (c) CME 30/10/60 (d) CME 35/35/31 composite. Blue and orange line-delimited regions indicate a polymer-rich and MTM-rich region, respectively. The large cracks are most likely artifacts from the ultramicrotoming method.



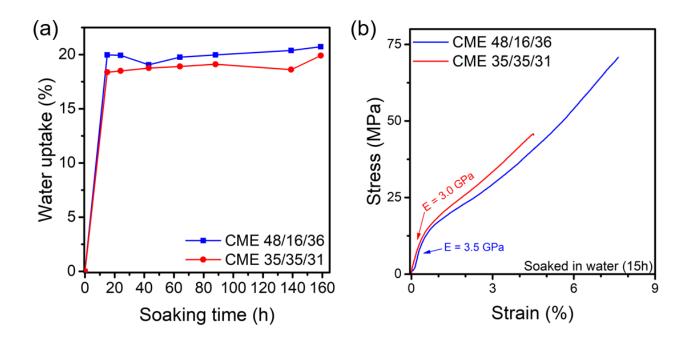
**Figure S2.** EDX for dark and bright region of TEM image. Si, Al, Fe, Mg are associated with MTM, C is associated with CNF/epoxy, Cu comes from the copper grid used for imaging.



**Figure S3.** Three-dimensional plot showing the individual effect of MTM and CNF on elastic modulus of the composites, at 50% RH. The 0% MTM data is taken from our earlier work.<sup>1</sup>

Sample	Relative	Young's	Ultimate	Yield	Strain at
	humidity	modulus	strength	strength	break (%)
	(%)	(GPa)	(MPa)	(MPa)	
Neat epoxy	50	$2.3 \pm 0.1$	32 ± 2	26 ± 3	$35.7\pm4.9$
	90	$2.1 \pm 0.2$	31 ± 6	25 ± 4	$33.8\pm6.0$
CME 35/35/31	50	$18.0\pm0.8$	139 ± 7	69 ± 1	$2.2\pm0.1$
	90	$11.9\pm0.7$	91 ± 8	54 ± 1	$2.0 \pm 0.5$
CME 24/24/52	50	$14.0\pm0.6$	$114 \pm 11$	N/A	$1.2 \pm 0.3$
	90	$10.5 \pm 1.1$	92 ± 4	75 ± 5	$1.6\pm0.3$
CME 13/13/74	50	$9.4\pm0.6$	101 ± 3	87 ± 3	$1.8\pm0.2$
	90	$8.6\pm0.7$	81 ± 2	77 ± 3	$2.4\pm0.4$
C1M1	50	$27.8\pm0.1$	219 ± 12	156 ± 2	$2.2\pm0.4$
	90	$17.9\pm0.1$	154 ± 7	98 ± 5	$2.4\pm0.4$
CME 48/16/36	50	$14.3\pm0.8$	133 ± 1	59 ± 2	$4.6\pm0.1$
	90	$8.5 \pm 0.5$	111 ± 7	38 ± 1	$6.6\pm0.4$
CME 30/10/60	50	$10.2 \pm 0.4$	110 ± 3	84 ± 5	$2.3\pm0.2$
	90	$8.5\pm0.2$	94 ± 3	72 ± 2	$4.6\pm0.1$
CME 15/5/80	50	$7.0 \pm 0.5$	107 ± 6	80 ± 6	$6.4\pm0.4$
	90	$6.9 \pm 0.4$	98 ± 3	70 ± 5	$11.2\pm0.6$
C3M1	50	$24.7\pm0.1$	280 ± 10	162 ± 7	$4.3\pm0.2$
	90	$15.3 \pm 0.1$	189 ± 4	91 ± 4	$4.4\pm0.3$

 Table S1. Mechanical properties for all samples and relative humidities.

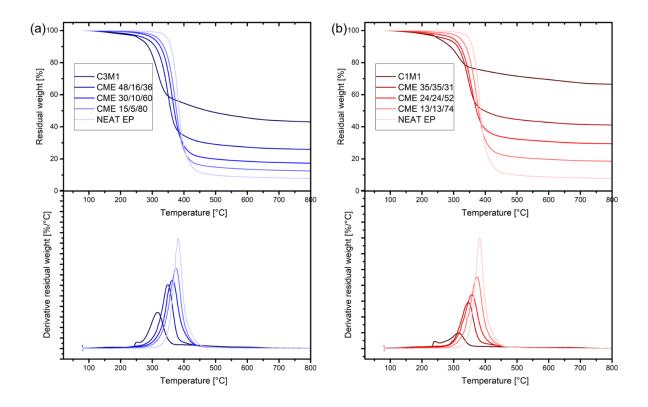


**Figure S4.** (a) Time-dependent water uptake of composites after immersion in Milli-Q water for 7 days. (b) Representative tensile stress-strain curves of high reinforcement fraction composites after immersion in Milli-Q water for 15 h.

**Table S2.** TGA peaks and residues in air and nitrogen atmospheres.

Sample	Tonset °C	T <sub>peak</sub> °C	Residue at 800	Organic residue
			°C, wt %	at 800 °C, wt %
CME 33/33/33 (N <sub>2</sub> )	310	349	38	10
CME 50/17/33 (N <sub>2</sub> )	307	350	26	12
CME 33/33/33 (Air)	308	349	32	4
CME 50/17/33 (Air)	296	350	20	5

 $T_{onset}$  is defined as the temperature at which 10% weight loss is reached. The organic residue was calculated assuming 85% residue for MTM at 800 °C in N<sub>2</sub> and air.



**Figure S5.** TGA curves in nitrogen atmosphere for all CME composites. (a) C3M1 series and (b) C1M1 series.

Table S3. Vertical flammability burning parameters	(burning time and residues).
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Sample	Burning time, s	Residues (wt %)
Neat EP	37 ± 12	No residues
CME 33/33/33	$4.7 \pm 0.6$	43 ± 5
CME 50/17/33	$5.3 \pm 0.6$	30 ± 1

## REFERENCES

1. Ansari, F.; Galland, S.; Johansson, M.; Plummer, C. J. G.; Berglund, L. A., Cellulose nanofiber network for moisture stable, strong and ductile biocomposites and increased epoxy curing rate. *Composites Part A: Applied Science and Manufacturing* **2014**, *63*, 35-44.